

Dual N-Channel MOSFET

General Description

The WSP4884 is the highest performance trench N-ch MOSFET with extreme high cell density, which provide excellent R_{DSON} and gate chargens for most of the synchronous buck converter applications .

The WSP4884 meet the RoHS and Green Product requirement,100% EAS guaranteed with full function reliability approved.

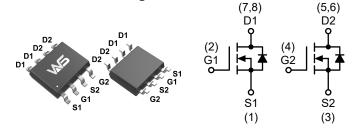
Product Summery

BV _{DSS}		I _D
30V	18.5mΩ	8.8A

Application

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

SOP-8L Pin Configuration



Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	30	V
V _{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	8.8	A
I _D @T _C =70℃	Continuous Drain Current, V _{GS} @ 10V ¹	7.0	A
I _{DM}	Pulsed Drain Current ²	40	A
EAS	Single Pulse Avalanche Energy ³	20	mJ
I _{AS}	Avalanche Current	9	А
P _D @T _A =25℃	Total Power Dissipation ⁴	2.0	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter		Max.	Unit
R _{θJA}	Thermal Resistance Junction-ambient ¹		90	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹		50	°C/W

Absolute Maximum Ratings



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Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V	
$\triangle BV_{DSS} / \triangle T_J$	BV _{DSS} Temperature Coefficient	Reference to 25 $^\circ\!\mathrm{C}$, I_D=1mA		0.034		V/℃	
Р	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =8.5A	8.5A 18.5		23		
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =4.5V , I _D =5A		25	27	mΩ	
V _{GS(th)}	Gate Threshold Voltage		1.5	1.8	2.5	V	
	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=250$ uA		-5.8		mV/°C	
		V _{DS} =24V , V _{GS} =0V , T _J =25°C			1		
I _{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}\text{=}24V$, $V_{\text{GS}}\text{=}0V$, $T_{\text{J}}\text{=}55^\circ\!\mathrm{C}$			5	uA	
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm20V$, $V_{DS}=0V$			±100	nA	
gfs	Forward Transconductance	V _{DS} =5V , I _D =8A		6		S	
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.7	2.5	Ω	
Qg	Total Gate Charge (4.5V)			6	8.4		
Q _{gs}	Gate-Source Charge	V_{DS} =15V , V_{GS} =4.5V , I_{D} =8.8A		1.5		nC	
Q _{gd}	Gate-Drain Charge			2.5			
T _{d(on)}	Turn-On Delay Time			6	8.8		
Tr	Rise Time	V_{DD} =15V , V_{GEN} =10V , R_{G} =6 Ω		8.2	14		
T _{d(off)}	Turn-Off Delay Time	I _D =1A,R∟=15Ω		4	8	ns	
T _f	Fall Time			16	24		
C _{iss}	Input Capacitance			580	701		
C _{oss}	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		95	112	pF	
C _{rss}	Reverse Transfer Capacitance			57	91		

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy 5	V _{DD} =25V , L=0.5mH , I _{AS} =9A	18			mJ

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,6}				2	А
I _{SM}	Pulsed Source Current ^{2,6}	V _G =V _D =0V , Force Current			40	А
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25℃			1.1	V
t _{rr}	Reverse Recovery Time			12		nS
Q _{rr}	Reverse Recovery Charge	IF=8A , dI/dt=100A/ μs , T _J =25 $^\circ C$		3.5		nC

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

3.The EAS data shows Max. rating . The test condition is $V_{\text{DD}}\text{=}25\text{V}, V_{\text{GS}}\text{=}10\text{V}, \text{L=}0.5\text{mH}, \text{I}_{\text{AS}}\text{=}9\text{A}$

4. The power dissipation is limited by 150° junction temperature

5. The Min. value is 100% EAS tested guarantee.

6.The data is theoretically the same as I_{D} and I_{DM} , in real applications , should be limited by total power dissipation.



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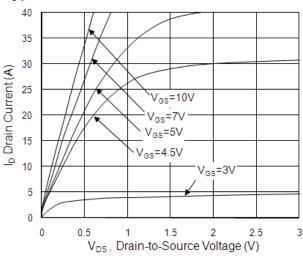


Fig.1 Typical Output Characteristics

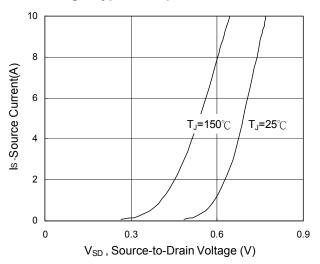
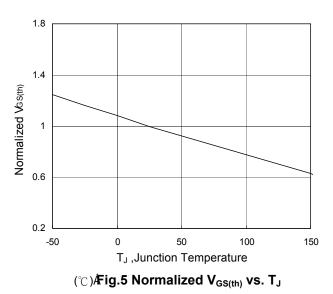


Fig.3 Forward Characteristics Of Reverse



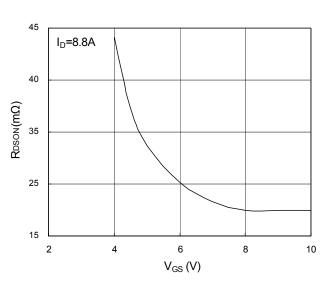


Fig.2 On-Resistance vs. G-S Voltage

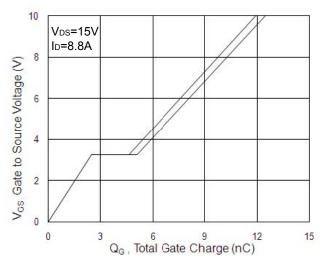
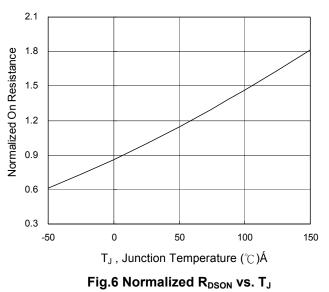


Fig.4 Gate-Charge Characteristics





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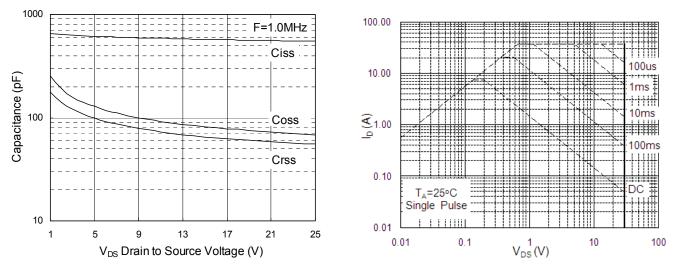


Fig.7 Capacitance

Fig.8 Safe Operating Area

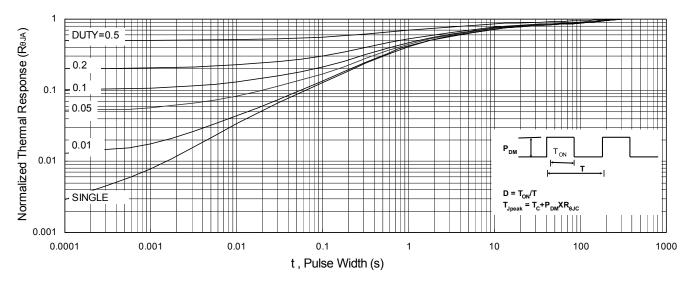
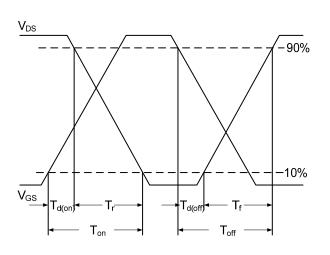
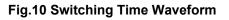


Fig.9 Normalized Maximum Transient Thermal Impedance





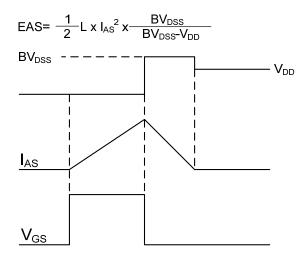
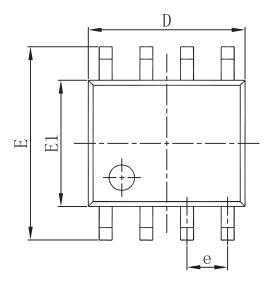


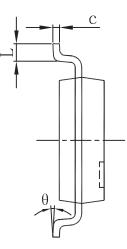
Fig.11 Unclamped Inductive Switching Waveform

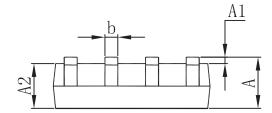


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Packaging information







Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
с	0.170	0.250	0.007	0.010	
D	4.800	5.000	0.189	0.197	
e	1.270 (BSC)		0.050 (BSC)		
Е	5.800	6. 200	0.228	0.244	
E1	3.800	4.000	0.150	0.157	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0 °	8°	



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